

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
XI'AN YISHEN OPTOELECTRONICS TECHNOLOGY CO., LTD.	04/21/2020
NINGBO SEMICONDUCTOR INTERNATIONAL CORPORATION	04/21/2020
RECEIVING PARTY DATA	
Name:	NINGBO SEMICONDUCTOR INTERNATIONAL CORPORATION
Street Address:	BUILDING 3, BUILDING 4 AND BUILDING 5, 335 ANJU ROAD, XIAOGANG STREET, BEILUN DISTRICT
City:	NINGBO
State/Country:	CHINA
Postal Code:	315800
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13896593
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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NAME OF SUBMITTER:	TING XUE
SIGNATURE:	/Ting Xue/
DATE SIGNED:	04/23/2020
Total Attachments: 2	
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ASSIGNMENT AGREEMENT

WHEREAS, Xi'an Yishen Optoelectronics Technology Co., Ltd., a corporation of P.R.China, whose post office address is No.204, Circular Arc Building, No.60, West Road, New Industrial Park, High-tech Zone, Xi'an, Shaanxi, China, 710119, and Ningbo Semiconductor International Corporation, a corporation of P.R.China, whose post office address is Building 3, Building 4 and Building 5, 335 Anju Road, Xiaogang Street, Beilun District, Ningbo, Zhejiang, China, 315800 (hereinafter referred to as Assignors), are the owners of entire rights of patents and patent applications listed in Appendix A (Assigned patents and patent applications);

WHEREAS, Ningbo Semiconductor International Corporation, a corporation of P.R.China, whose post office address is Building 3, Building 4 and Building 5, 335 Anju Road, Xiaogang Street, Beilun District, Ningbo, Zhejiang, China, 315800, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to the Assigned patents and patent applications;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, the Assignor has sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, the entire right, title, and interest in and to the Assigned patents and patent applications, and all divisions, and continuations, continuations-in-part, and substitutions thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority thereof; and the Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States to issue all Letters Patents for the Assigned patents and patent applications to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, Assignor HEREBY covenants that the Assignor has the full right to convey the interest assigned by this Assignment, and Assignor has not executed and will not execute any agreement in conflict with this Assignment;

IN TESTIMONY WHEREOF, We have hereunto set our hands.

Xi'an Yishen Optoelectronics Technology Co., Ltd.
No.204, Circular Arc Building, No.60, West Road, New Industrial Park, High-tech Zone,
Xi'an, Shaanxi, China, 710119

Signature: Cuizhengde

Name: Cuizhengde

Title: legod person

Date: 21 April, 2020

Ningbo Semiconductor International Corporation
Building 3, Building 4 and Building 5, 335 Anju Road, Xiaogang Street, Beilun District,
Ningbo, Zhejiang, China, 315800

Signature: WenFen Chang
Name: WenFenchang
Title: legal director
Date: 4/21/2020

Appendix A

Application No./ Patent No.	Filing Date/ Issue Date
13/896,593	2013-05-17